

# MJD44H11, NJVMJD44H11 (NPN), MJD45H11, NJVMJD45H11 (PNP)

## Complementary Power Transistors

### DPAK For Surface Mount Applications

Designed for general purpose power and switching such as output or driver stages in applications such as switching regulators, converters, and power amplifiers.

#### Features

- Lead Formed for Surface Mount Application in Plastic Sleeves (No Suffix)
- Straight Lead Version in Plastic Sleeves (“-1” Suffix)
- Electrically Similar to Popular D44H/D45H Series
- Low Collector Emitter Saturation Voltage –  
 $V_{CE(sat)} = 1.0 \text{ Volt Max @ } 8.0 \text{ A}$
- Fast Switching Speeds
- Complementary Pairs Simplifies Designs
- Epoxy Meets UL 94 V-0 @ 0.125 in
- ESD Ratings: Human Body Model, 3B > 8000 V  
Machine Model, C > 400 V
- NJV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These are Pb-Free Packages\*

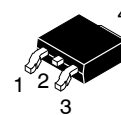


ON Semiconductor®

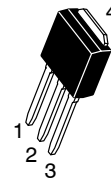
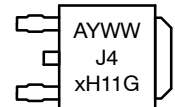
<http://onsemi.com>

**SILICON  
POWER TRANSISTORS  
8 AMPERES  
80 VOLTS, 20 WATTS**

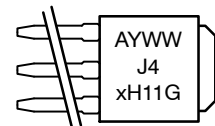
#### MARKING DIAGRAMS



**DPAK  
CASE 369C  
STYLE 1**



**IPAK  
CASE 369D  
STYLE 1**



A	=	Assembly Location
Y	=	Year
WW	=	Work Week
J4xH11	=	Device Code x = 4 or 5
G	=	Pb-Free Package

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## MJD44H11, NJVMJD44H11 (NPN), MJD45H11, NJVMJD45H11 (PNP)

**MAXIMUM RATINGS** ( $T_A = 25^\circ\text{C}$ , common for NPN and PNP, minus sign, “-”, for PNP omitted, unless otherwise noted)

Rating	Symbol	Max	Unit
Collector-Emitter Voltage	$V_{CEO}$	80	Vdc
Emitter-Base Voltage	$V_{EB}$	5	Vdc
Collector Current – Continuous – Peak	$I_C$	8 16	Adc
Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	20 0.16	W W/ $^\circ\text{C}$
Total Power Dissipation (Note 1) @ $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	1.75 0.014	W W/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	-55 to +150	$^\circ\text{C}$

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	6.25	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{\theta JA}$	71.4	$^\circ\text{C}/\text{W}$
Lead Temperature for Soldering	$T_L$	260	$^\circ\text{C}$

1. These ratings are applicable when surface mounted on the minimum pad sizes recommended.

# MJD44H11, NJVMJD44H11 (NPN), MJD45H11, NJVMJD45H11 (PNP)

## ELECTRICAL CHARACTERISTICS

( $T_A = 25^\circ\text{C}$ , common for NPN and PNP, minus sign, “-”, for PNP omitted, unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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### OFF CHARACTERISTICS

Collector–Emitter Sustaining Voltage ( $I_C = 30\text{ mA}$ , $I_B = 0$ )	$V_{CE(sus)}$	80			Vdc
Collector Cutoff Current ( $V_{CE} = \text{Rated } V_{CE0}$ , $V_{BE} = 0$ )	$I_{CES}$			1.0	$\mu\text{A}$
Emitter Cutoff Current ( $V_{EB} = 5\text{ Vdc}$ )	$I_{EBO}$			1.0	$\mu\text{A}$

### ON CHARACTERISTICS

Collector–Emitter Saturation Voltage ( $I_C = 8\text{ Adc}$ , $I_B = 0.4\text{ Adc}$ )	$V_{CE(sat)}$			1	Vdc
Base–Emitter Saturation Voltage ( $I_C = 8\text{ Adc}$ , $I_B = 0.8\text{ Adc}$ )	$V_{BE(sat)}$			1.5	Vdc
DC Current Gain ( $V_{CE} = 1\text{ Vdc}$ , $I_C = 2\text{ Adc}$ )	$h_{FE}$	60			–
DC Current Gain ( $V_{CE} = 1\text{ Vdc}$ , $I_C = 4\text{ Adc}$ )		40			

### DYNAMIC CHARACTERISTICS

Collector Capacitance ( $V_{CB} = 10\text{ Vdc}$ , $f_{\text{test}} = 1\text{ MHz}$ )	MJD44H11, NJVMJD44H11G,/T4G/RLG MJD45H11, NJVMJD45H11T4G/RLG	$C_{cb}$		45 130	pF
Gain Bandwidth Product ( $I_C = 0.5\text{ Adc}$ , $V_{CE} = 10\text{ Vdc}$ , $f = 20\text{ MHz}$ )	MJD44H11, NJVMJD44H11G,/T4G/RLG MJD45H11, NJVMJD45H11T4G/RLG	$f_T$		85 90	MHz

### SWITCHING TIMES

Delay and Rise Times ( $I_C = 5\text{ Adc}$ , $I_{B1} = 0.5\text{ Adc}$ )	MJD44H11, NJVMJD44H11G,/T4G/RLG MJD45H11, NJVMJD45H11T4G/RLG	$t_d + t_r$		300 135	ns
Storage Time ( $I_C = 5\text{ Adc}$ , $I_{B1} = I_{B2} = 0.5\text{ Adc}$ )	MJD44H11, NJVMJD44H11G,/T4G/RLG MJD45H11, NJVMJD45H11T4G/RLG	$t_s$		500 500	ns
Fall Time ( $I_C = 5\text{ Adc}$ , $I_{B1} = I_{B2} = 0.5\text{ Adc}$ )	MJD44H11, NJVMJD44H11G,/T4G/RLG MJD45H11, NJVMJD45H11T4G/RLG	$t_f$		140 100	ns

MJD44H11, NJVMJD44H11 (NPN), MJD45H11, NJVMJD45H11 (PNP)

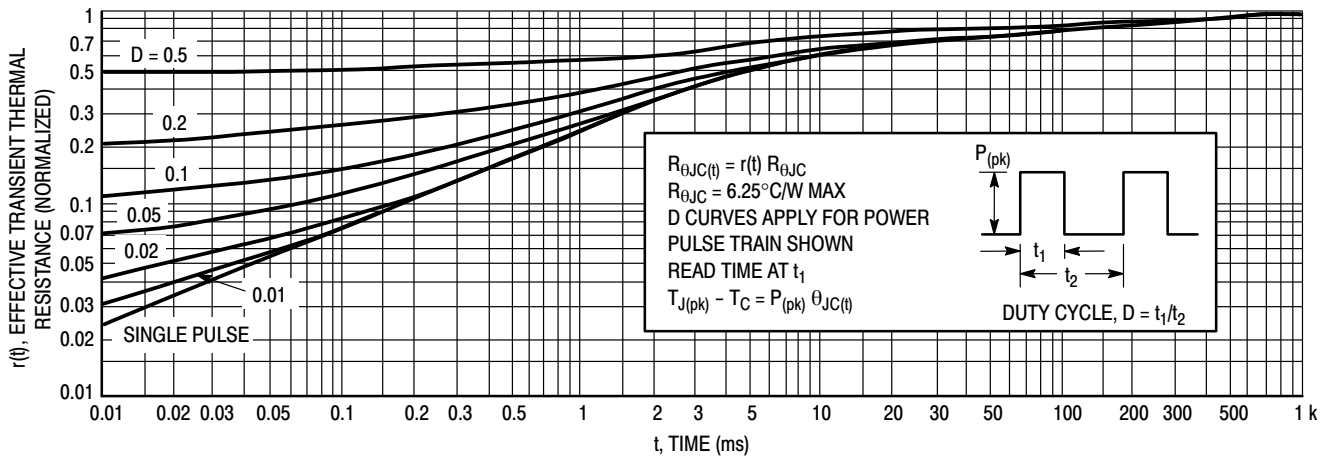


Figure 1. Thermal Response

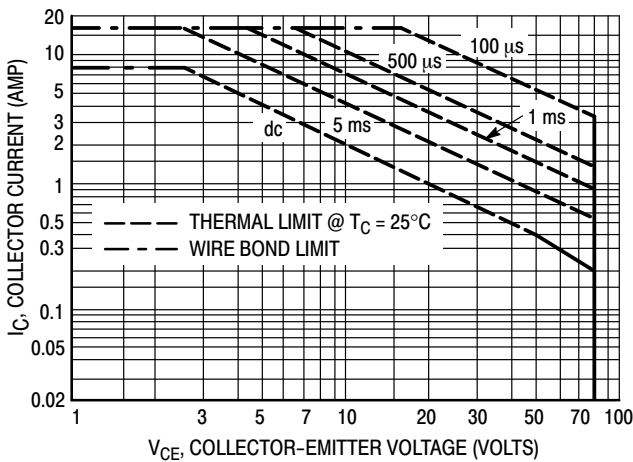


Figure 2. Maximum Forward Bias Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 2 is based on  $T_{J(pk)} = 150^\circ\text{C}$ ;  $T_C$  is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided  $T_{J(pk)} \leq 150^\circ\text{C}$ .  $T_{J(pk)}$  may be calculated from the data in Figure 1. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

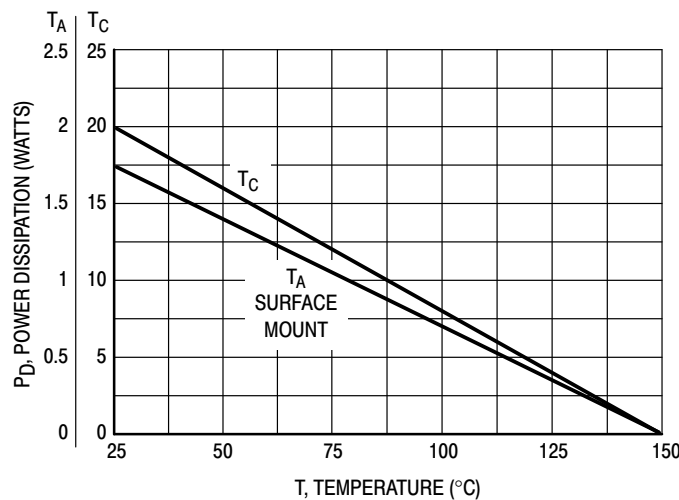


Figure 3. Power Derating

MJD44H11, NJVMJD44H11 (NPN), MJD45H11, NJVMJD45H11 (PNP)

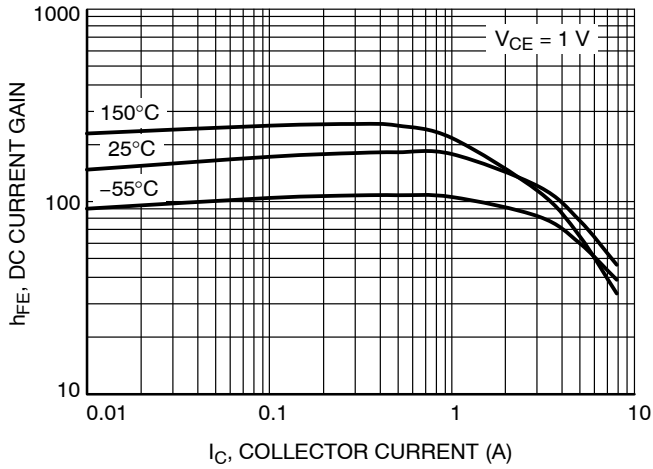


Figure 4. MJD44H11 DC Current Gain

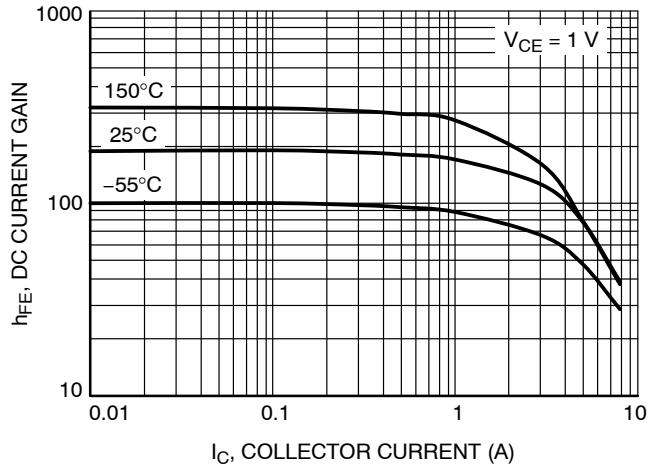


Figure 5. MJD45H11 DC Current Gain

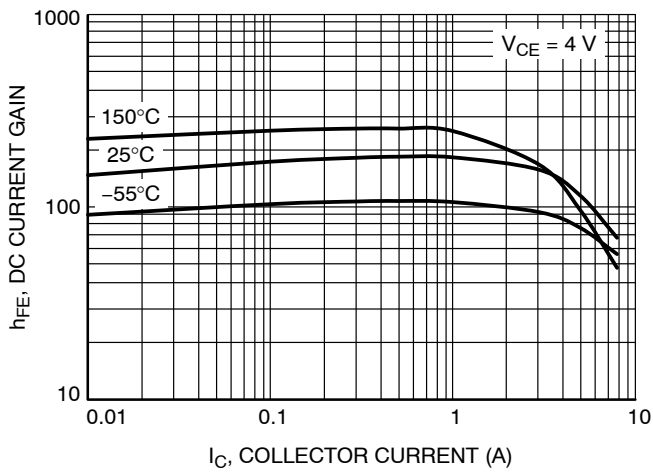


Figure 6. MJD44H11 DC Current Gain

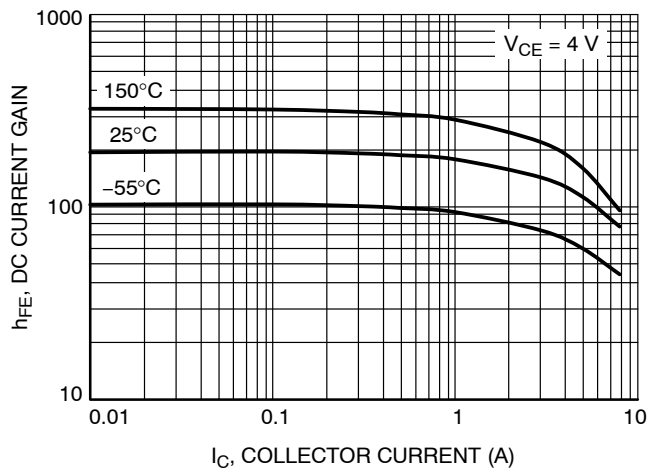


Figure 7. MJD45H11 DC Current Gain

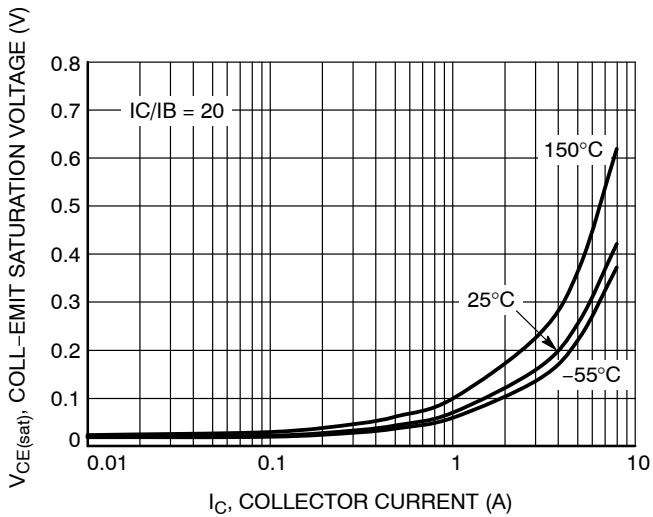


Figure 8. MJD44H11 Saturation Voltage  
 $V_{CE(sat)}$

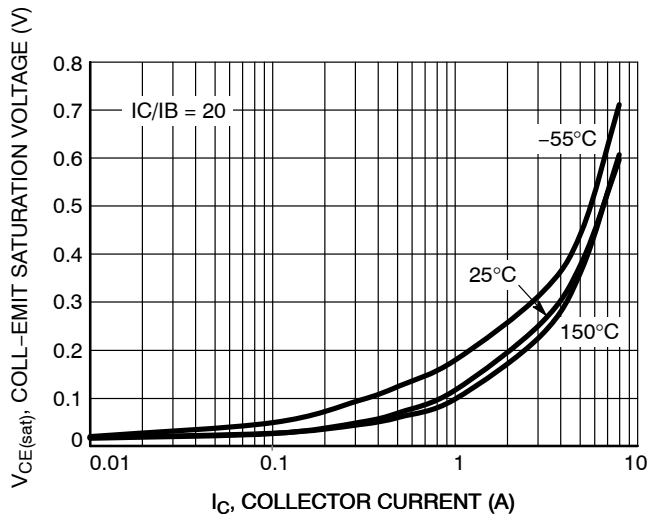


Figure 9. MJD45H11 Saturation Voltage  
 $V_{CE(sat)}$

MJD44H11, NJVMJD44H11 (NPN), MJD45H11, NJVMJD45H11 (PNP)

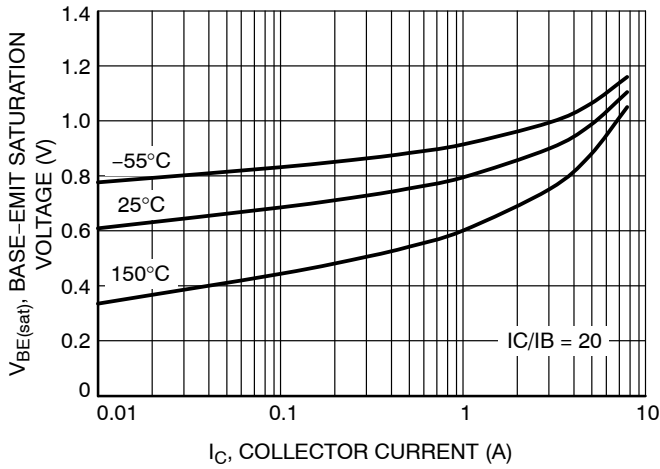


Figure 10. MJD44H11 Saturation Voltage  
 $V_{BE(sat)}$

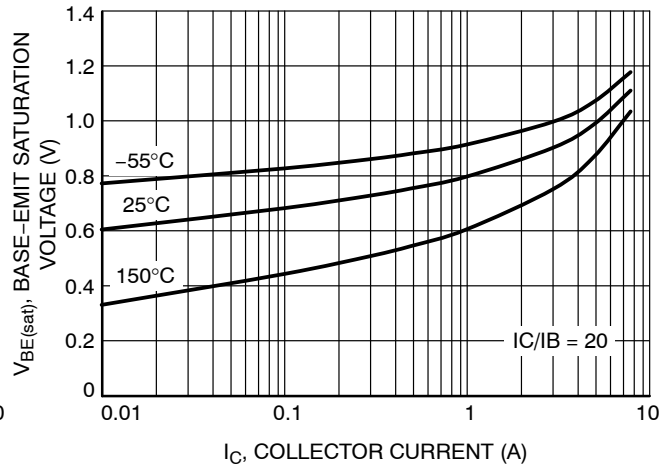


Figure 11. MJD45H11 Saturation Voltage  
 $V_{BE(sat)}$

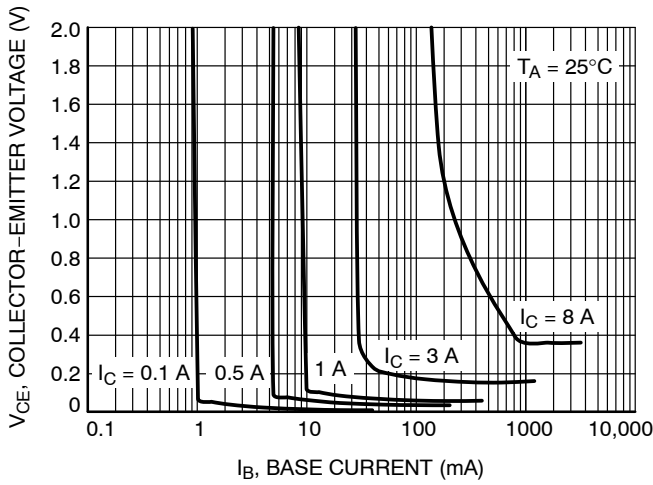


Figure 12. MJD44H11 Collector Saturation Region

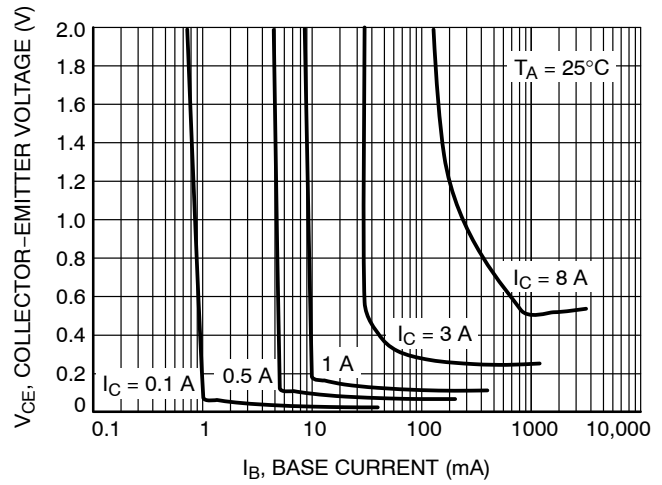


Figure 13. MJD45H11 Collector Saturation Region

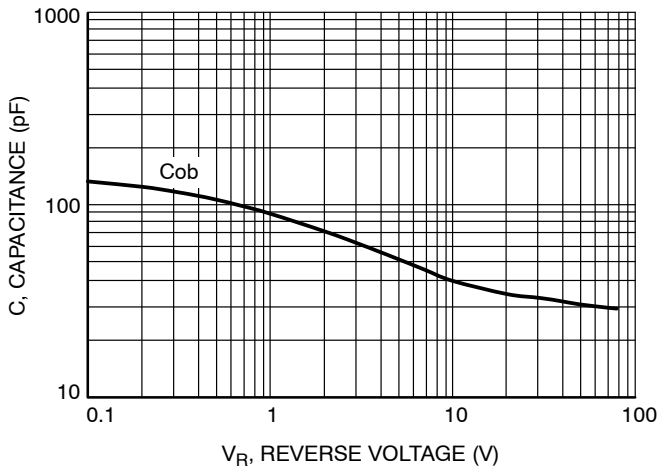


Figure 14. MJD44H11 Capacitance

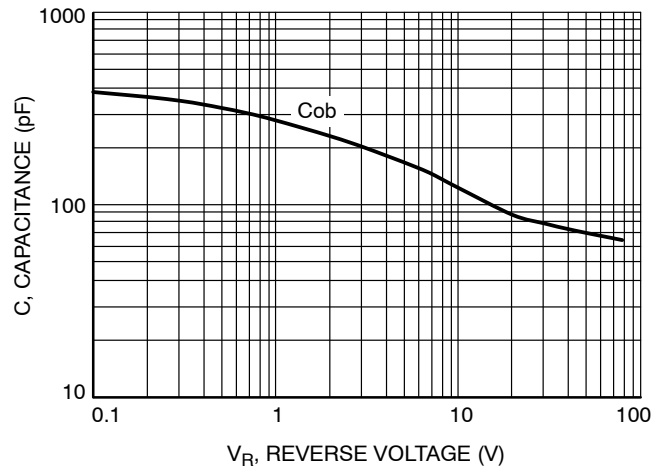
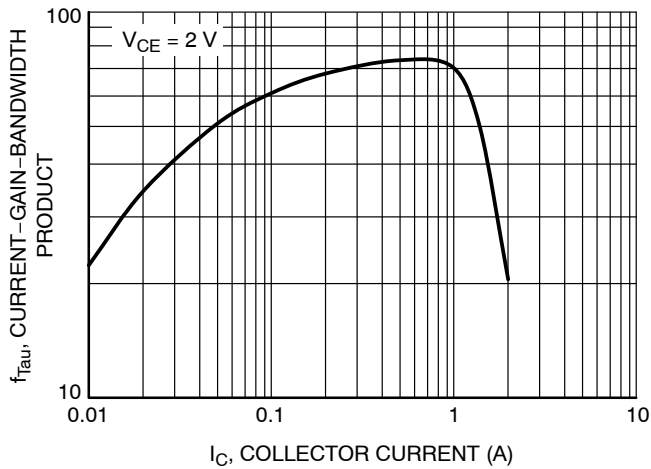
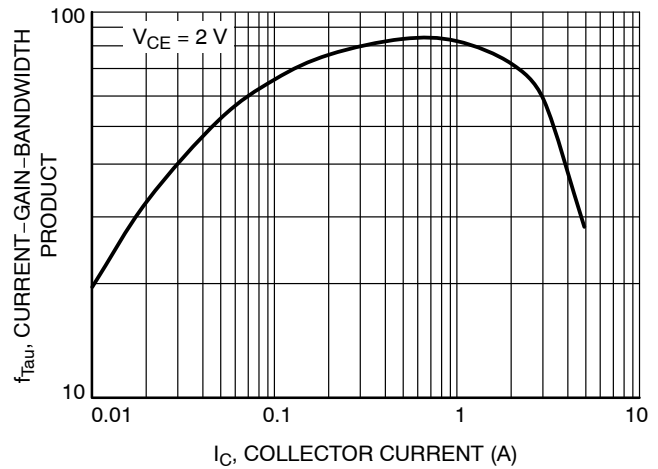


Figure 15. MJD45H11 Capacitance

## MJD44H11, NJVMJD44H11 (NPN), MJD45H11, NJVMJD45H11 (PNP)



**Figure 16. MJD44H11  
Current-Gain-Bandwidth Product**



**Figure 17. MJD45H11  
Current-Gain-Bandwidth Product**

### ORDERING INFORMATION

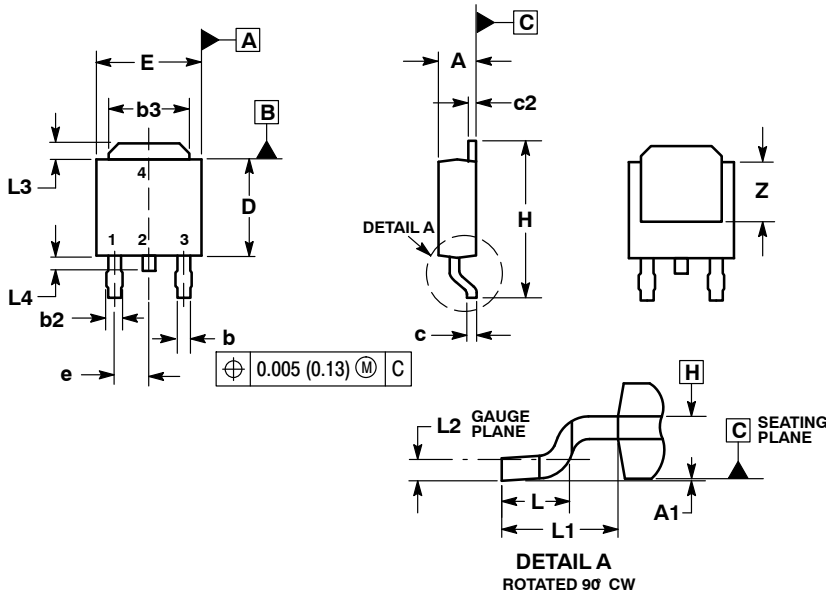
Device	Package Type	Package	Shipping <sup>†</sup>
MJD44H11G	DPAK (Pb-Free)	369C	75 Units / Rail
NJVMJD44H11G	DPAK (Pb-Free)		
MJD44H11-1G	DPAK-3 (Pb-Free)	369D	
MJD44H11RLG	DPAK (Pb-Free)	369C	1,800 / Tape & Reel
NJVMJD44H11RLG	DPAK (Pb-Free)		
MJD44H11T4G	DPAK (Pb-Free)		2,500 / Tape & Reel
NJVMJD44H11T4G	DPAK (Pb-Free)		
MJD44H11T5G	DPAK (Pb-Free)		
MJD45H11G	DPAK (Pb-Free)	369D	75 Units / Rail
MJD45H11-1G	DPAK-3 (Pb-Free)		
MJD45H11RLG	DPAK (Pb-Free)	369C	1,800 / Tape & Reel
NJVMJD45H11RLG	DPAK (Pb-Free)		
MJD45H11T4G	DPAK (Pb-Free)		2,500 / Tape & Reel
NJVMJD45H11T4G	DPAK (Pb-Free)		

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# MJD44H11, NJVMJD44H11 (NPN), MJD45H11, NJVMJD45H11 (PNP)

## PACKAGE DIMENSIONS

### DPAK CASE 369C ISSUE D

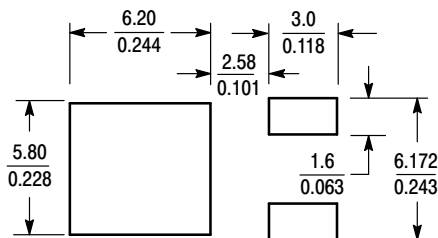


**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: INCHES.
3. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS b3, L3 and Z.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.006 INCHES PER SIDE.
5. DIMENSIONS D AND E ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
6. DATUMS A AND B ARE DETERMINED AT DATUM PLANE H.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.086	0.094	2.18	2.38
A1	0.000	0.005	0.00	0.13
b	0.025	0.035	0.63	0.89
b2	0.030	0.045	0.76	1.14
b3	0.180	0.215	4.57	5.46
c	0.018	0.024	0.46	0.61
c2	0.018	0.024	0.46	0.61
D	0.235	0.245	5.97	6.22
E	0.250	0.265	6.35	6.73
e	0.090 BSC		2.29 BSC	
H	0.370	0.410	9.40	10.41
L	0.055	0.070	1.40	1.78
L1	0.108 REF		2.74 REF	
L2	0.020 BSC		0.51 BSC	
L3	0.035	0.050	0.89	1.27
L4	---	0.040	---	1.01
Z	0.155	---	3.93	---

### SOLDERING FOOTPRINT\*



SCALE 3:1  $\left(\frac{\text{mm}}{\text{inches}}\right)$

**STYLE 1:**

- PIN 1: BASE  
 2. COLLECTOR  
 3. EMITTER  
 4. COLLECTOR

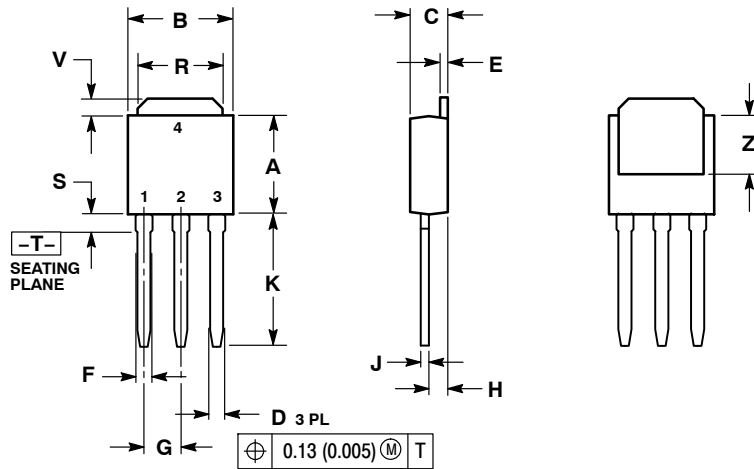
\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



# MJD44H11, NJVMJD44H11 (NPN), MJD45H11, NJVMJD45H11 (PNP)

## PACKAGE DIMENSIONS

### IPAK CASE 369D ISSUE C



#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.235	0.245	5.97	6.35
B	0.250	0.265	6.35	6.73
C	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
E	0.018	0.023	0.46	0.58
F	0.037	0.045	0.94	1.14
G	0.090	BSC	2.29	BSC
H	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.350	0.380	8.89	9.65
R	0.180	0.215	4.45	5.45
S	0.025	0.040	0.63	1.01
V	0.035	0.050	0.89	1.27
Z	0.155	---	3.93	---

#### STYLE 1:

- PIN 1. BASE
- COLLECTOR
- EMITTER
- COLLECTOR

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